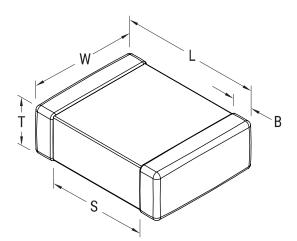


CAN19X823MAGAC7210

CAN SMD Indust 250, Ceramic, 0.082 uF, 20%, COG, SMD Chip, MLCC, AC Rated, 1825, 2.3 $\rm mm$



Click here for the 3D model.

| Dimensions | |
|------------|-----------------|
| Chip Size | 1825 |
| L | 4.6mm +/-0.4mm |
| W | 6.4mm +/-0.4mm |
| т | 2.5mm +/-0.20mm |
| S | 2.3mm MIN |
| В | 0.7mm +/-0.35mm |
| | |

Packaging Specifications

PackagingT&R, 330mm, Plastic TapePackaging Quantity2000

| General Information | |
|--------------------------|-----------------------------|
| Series | CAN SMD Indust 250 |
| Style | SMD Chip |
| Description | SMD Chip, MLCC, AC Rated |
| Features | Temperature Stable, Class I |
| RoHS | Yes |
| Termination | Flexible Termination |
| Marking | No |
| AEC-Q200 | No |
| Typical Component Weight | 310 mg |
| Shelf Life | 78 Weeks |
| MSL | 1 |

| Specifications | |
|--|---------------------|
| Capacitance | 0.082 uF |
| Measurement Condition | 1 kHz 1.0Vrms |
| Tolerance | 20% |
| Voltage AC | 250 VAC |
| Dielectric Withstanding Voltage | 945 VDC |
| Temperature Range | -55/+125°C |
| Temp. Coefficient | COG |
| Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC) | 15%, 1kHz 1.0Vrms |
| Dissipation Factor | 0.1% 1 kHz 1.0Vrms |
| Aging Rate | 0% Loss/Decade Hour |
| Insulation Resistance | 10 GOhms |

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute – and we specifically disclaim – any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.